

N-channel 25 V 1.2 m Ω logic level MOSFET in LFPAK

Rev. 01 — 25 June 2009

Product data sheet

1. Product profile

1.1 General description

Logic level N-channel MOSFET in LFPAK package qualified to 150 °C. This product is designed and qualified for use in a wide range of industrial, communications and domestic equipment.

1.2 Features and benefits

- Advanced TrenchMOS provides low RDSon and low gate charge
- High efficiency gains in switching power converters

1.3 Applications

- DC-to-DC converters
- Lithium-ion battery protection
- Load switching

1.4 Quick reference data

Table 1. Quick reference

- Improved mechanical and thermal characteristics
- LFPAK provides maximum power density in a Power SO8 package
- Motor control
- Server power supplies

	QUICK reference						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{DS}	drain-source voltage	T _j ≥ 25 °C; T _j ≤ 150 °C		-	-	25	V
ID	drain current	$T_{mb} = 25 \text{ °C}; V_{GS} = 10 \text{ V};$ see <u>Figure 1</u>	[1]	-	-	100	A
P _{tot}	total power dissipation	T _{mb} = 25 °C; see <u>Figure 2</u>		-	-	121	W
Tj	junction temperature			-55	-	150	°C
Avalancl	he ruggedness						
E _{DS(AL)S}	non-repetitive drain-source avalanche energy			-	-	677	mJ
Dynamic	characteristics						
Q _{GD}	gate-drain charge	$V_{GS} = 4.5 \text{ V}; I_D = 25 \text{ A};$		-	11.9	-	nC
Q _{G(tot)}	total gate charge	V _{DS} = 12 V; see <u>Figure 12</u> ; see <u>Figure 13</u>		-	50.6	-	nC

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Table 1. Quick reference continued							
Symbol	Parameter	Conditions	Min	Тур	Max	Unit	
Static ch	naracteristics						
R _{DSon}	drain-source on-state resistance	$V_{GS} = 10 \text{ V}; I_D = 15 \text{ A};$ $T_j = 100 \text{ °C}; \text{ see } Figure 11$	-	-	1.6	mΩ	
		V _{GS} = 10 V; I _D = 15 A; T _j = 25 °C; see <u>Figure 10</u>	-	0.9	1.2	mΩ	

[1] Continuous current is limited by package.

2. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	S	source		-
2	S	source		
3	S	source		
4	G	gate		
mb	D	drain		mbb076 S
			SOT1023 (LFPAK2)	

3. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PSMN1R2-25YL	LFPAK2	Plastic single-ende surface-mounted package (LFPAK2); 4 leads	SOT1023

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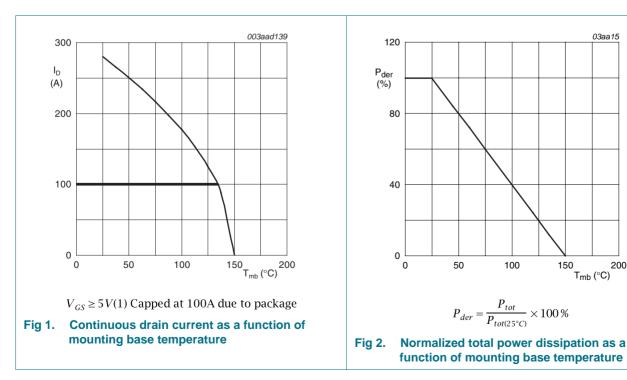
Limiting values 4.

Table 4. **Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{DS}	drain-source voltage	T _j ≥ 25 °C; T _j ≤ 150 °C		-	25	V
V _{DGR}	drain-gate voltage	$T_j \ge 25 \text{ °C}; T_j \le 150 \text{ °C}; R_{GS} = 20 \text{ k}\Omega$		-	25	V
V_{GS}	gate-source voltage			-20	20	V
I _D	drain current	V _{GS} = 10 V; T _{mb} = 100 °C; see <u>Figure 1</u>	[1]	-	100	А
		V_{GS} = 10 V; T_{mb} = 25 °C; see <u>Figure 1</u>	[1]	-	100	А
I _{DM}	peak drain current	$t_p \le 10 \ \mu s$; pulsed; $T_{mb} = 25 \ ^{\circ}C$; see Figure 3		-	815	А
P _{tot}	total power dissipation	T _{mb} = 25 °C; see <u>Figure 2</u>		-	121	W
T _{stg}	storage temperature			-55	150	°C
Tj	junction temperature			-55	150	°C
T _{sld(M)}	peak soldering temperature			-	260	°C
Source-dr	ain diode					
I _S	source current	T _{mb} = 25 °C;	[1]	-	100	А
I _{SM}	peak source current	$t_p \le 10 \ \mu s$; pulsed; $T_{mb} = 25 \ ^{\circ}C$		-	815	А
Avalanche	ruggedness					
E _{DS(AL)S}	non-repetitive drain-source avalanche energy	V_{GS} = 10 V; $T_{j(init)}$ = 25 °C; I_{D} = 100 A; V_{sup} ≤ 25 V; R_{GS} = 50 $\Omega;$ unclamped		-	677	mJ

[1] Continuous current is limited by package.

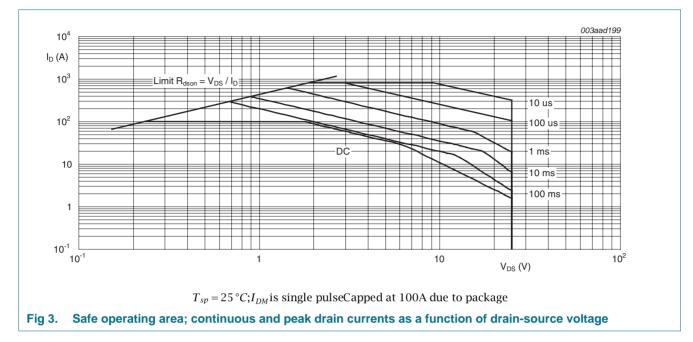


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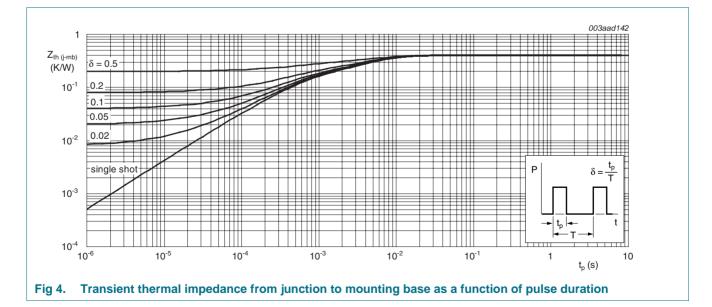
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5. Thermal characteristics

Table 5.Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	see Figure 4	-	0.4	1	K/W



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6. Characteristics

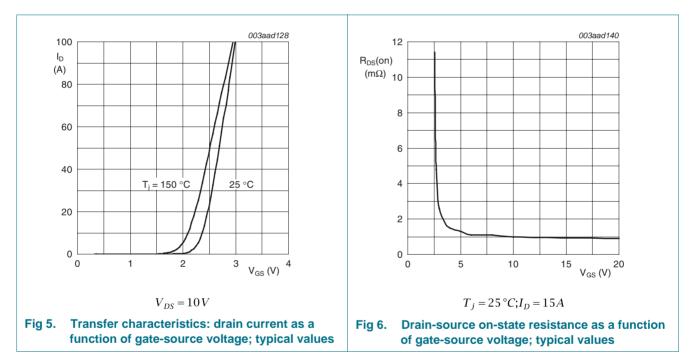
Table 6.	Characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	aracteristics					
V _{(BR)DSS}	drain-source	$I_D = 250 \ \mu\text{A}; \ V_{GS} = 0 \ V; \ T_j = 25 \ ^\circ\text{C}$	25	-	-	V
	breakdown voltage	I_D = 250 µA; V_{GS} = 0 V; T_j = -55 °C	22	-	-	V
V _{GS(th)}	gate-source threshold voltage	$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C};$ see <u>Figure 8</u> ; see <u>Figure 9</u>	1.3	1.7	2.15	V
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 150 \text{ °C};$ see <u>Figure 9</u>	0.65	-	-	V
		I _D = 1 mA; V _{DS} = V _{GS} ; T _j = -55 °C; see <u>Figure 9</u>	-	-	2.45	V
I _{DSS}	drain leakage current	$V_{DS} = 25 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$	-	-	1.5	μA
		$V_{DS} = 25 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 150 \text{ °C}$	-	-	500	μA
I _{GSS}	gate leakage current	V_{GS} = 16 V; V_{DS} = 0 V; T_j = 25 °C	-	-	100	nA
		V_{GS} = -16 V; V_{DS} = 0 V; T_j = 25 °C	-	-	100	nA
R _{DSon}	drain-source on-state resistance	V _{GS} = 4.5 V; I _D = 15 A; T _j = 25 °C; see <u>Figure 10</u>	-	1.2	1.85	mΩ
		V _{GS} = 10 V; I _D = 15 A; T _j = 100 °C; see <u>Figure 11</u>	-	-	1.6	mΩ
		V _{GS} = 10 V; I _D = 15 A; T _j = 150 °C; see <u>Figure 11</u>	-	-	2.1	mΩ
		V _{GS} = 10 V; I _D = 15 A; T _j = 25 °C; see <u>Figure 10</u>	-	0.9	1.2	mΩ
R _G	gate resistance	f = 1 MHz	-	0.94	-	Ω
Dynamic	characteristics					
$Q_{G(tot)}$ total gate charge	$I_D = 25 \text{ A}; V_{DS} = 12 \text{ V}; V_{GS} = 10 \text{ V};$ see <u>Figure 12</u> ; see <u>Figure 13</u>	-	105	-	nC	
		$I_D = 25 \text{ A}; V_{DS} = 12 \text{ V}; V_{GS} = 4.5 \text{ V};$ see Figure 12; see Figure 13	-	50.6	-	nC
Q _{GS}	gate-source charge	$I_D = 25 \text{ A}; V_{DS} = 12 \text{ V}; V_{GS} = 4.5 \text{ V};$	-	19.3	-	nC
Q _{GS(th)}	pre-threshold gate-source charge	see <u>Figure 12</u> ; see <u>Figure 13</u>	-	8.1	-	nC
Q _{GS(th-pl)}	post-threshold gate-source charge		-	4.5	-	nC
Q _{GD}	gate-drain charge		-	11.9	-	nC
V _{GS(pl)}	gate-source plateau voltage	V _{DS} = 12 V; see <u>Figure 12</u>	-	2.6	-	V
C _{iss}	input capacitance	$V_{DS} = 12 \text{ V}; V_{GS} = 0 \text{ V}; f = 1 \text{ MHz};$	-	6380	-	pF
C _{oss}	output capacitance	T _j = 25 °C; see <u>Figure 14</u>	-	1640	-	pF
C _{rss}	reverse transfer capacitance		-	644	-	pF

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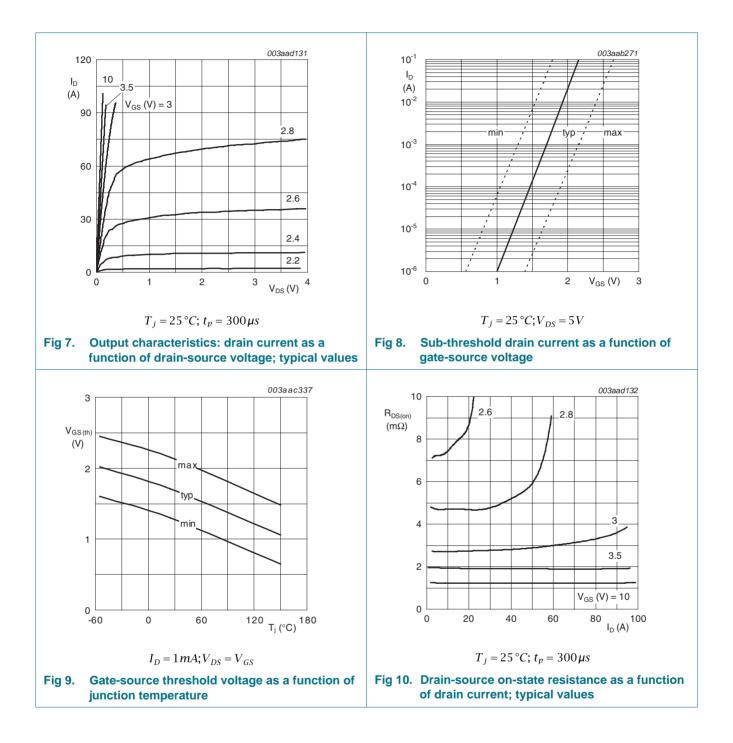
Table 6.	6. Characteristics continued					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
t _{d(on)}	turn-on delay time	V_{DS} = 12 V; R_L = 0.5 $\Omega;$ V_{GS} = 4.5 V;	-	69	-	ns
t _r	rise time	$R_{G(ext)} = 5.6 \Omega$	-	125	-	ns
t _{d(off)}	turn-off delay time		-	94	-	ns
t _f	fall time		-	56	-	ns
Source-d	rain diode					
V _{SD}	source-drain voltage	I _S = 25 A; V _{GS} = 0 V; T _j = 25 °C; see <u>Figure 15</u>	-	0.78	1.2	V
t _{rr}	reverse recovery time	I_S = 20 A; dI _S /dt = -100 A/µs; V _{GS} = 0 V;	-	52	-	ns
Qr	recovered charge	$V_{DS} = 20 V$	-	66	-	nC

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[1] Tested to JEDEC standards where applicable.



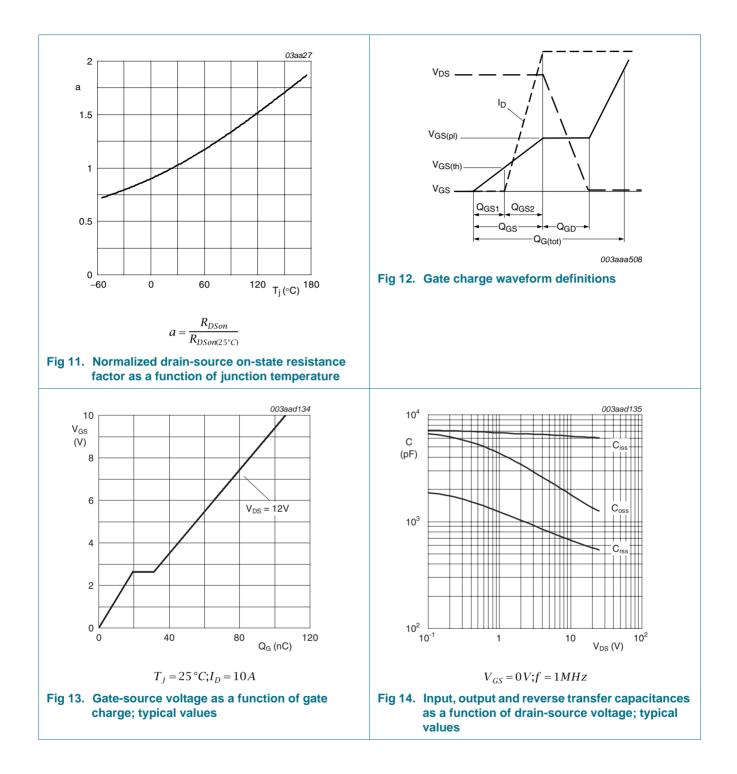
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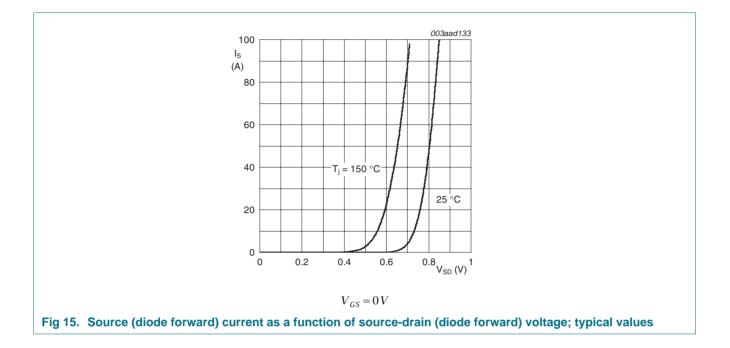
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7. Package outline

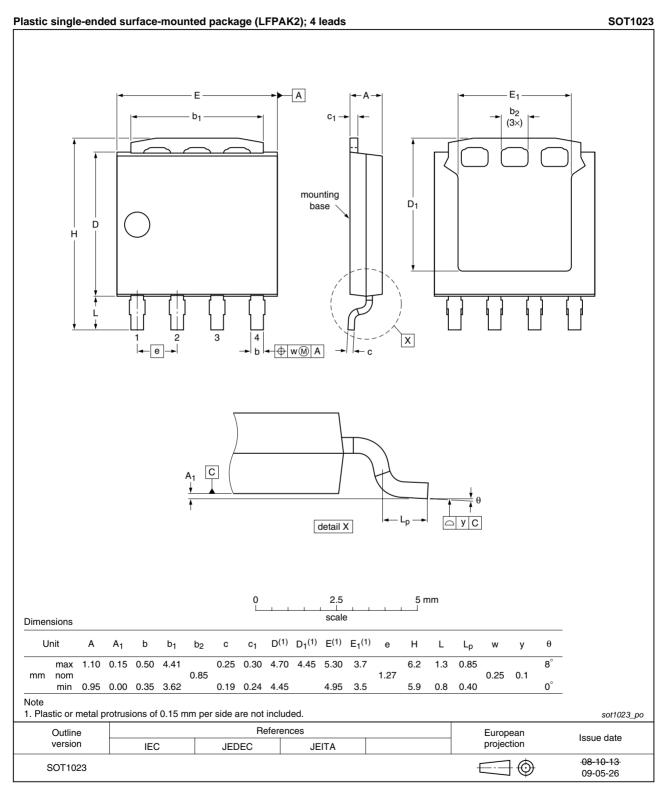


Fig 16. Package outline SOT1023

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8. Revision history

Table 7. Revision history				
Document ID	Release date	Data sheet status	Change notice	Supersedes
PSMN1R2-25YL_1	20090625	Product data sheet	-	-

9. Legal information

9.1 Data sheet status

Document status [1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions"

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nexperia.com.

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